



2019 International Conference on Compound Semiconductor Manufacturing Technology

April 29th – May 2nd, 2019

Hyatt Regency

Minneapolis, MN, USA



Call For Papers

Photo by Dan Anderson, Courtesy of Meet Minneapolis

**Abstracts Due
October 31, 2018**

Visit www.csmantech.org for link to submit a 1-2 page abstract

Online abstract submission site opens September 4, 2018

Conference Chair

Patrick Fay
chairman@csmantech.org

Technical Program Chair

Thorsten Saeger
tpcchair@csmantech.org

Abstracts should clearly state:

- The purpose of the work
- How CS Manufacturing Technology was used or advanced
- Specific results & how they were achieved with supporting data

Abstract formatting guidelines at www.csmantech.org/authorkit/

Papers Are Solicited on Manufacturing-Related Topics:

- 5G Devices and Circuits
- RF & Power Devices
- Optical Devices, LEDs, VCSELs
- Process Improvement Methodologies, SixSigma®, CPI
- Wafer & Device Processing
- Process Control & Yield
- Epitaxy & Materials
- SAW/BAW Filters
- Test & Reliability
- Packaging
- Heterogeneous Integration
- Business/Market Outlook
- Equipment

GaN, GaAs, InP, SiC, ultra-wide bandgap semiconductors, Sb compounds, SiGe, and other related materials

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